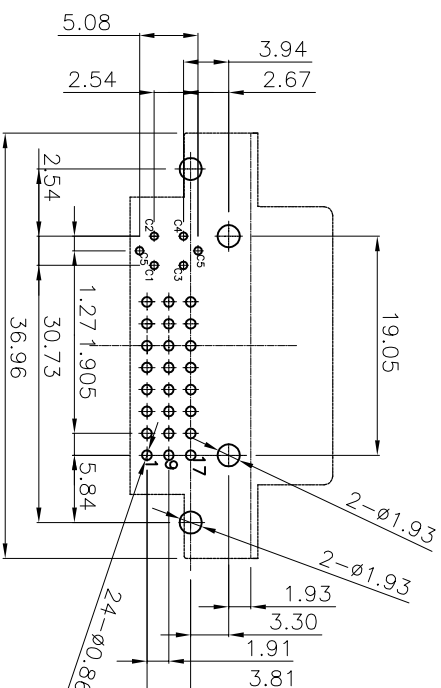
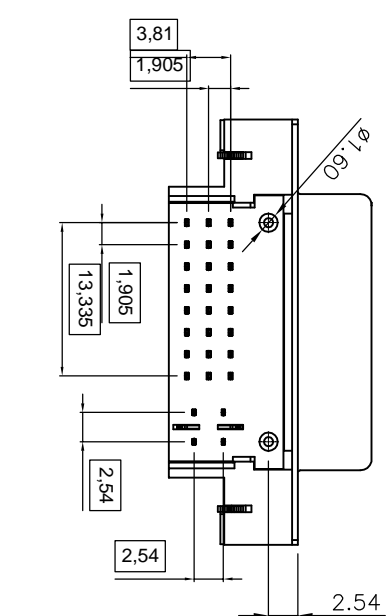



1. HOUSING: THERMOPLASTIC (UL 94V-0).
  2. COVER: THERMOPLASTIC (UL 94V-0).
  3. TERMINAL: COPPER ALLOY,  
GOLD PLATED ON CONTACT AREA,  
TIN PLATED ON SOLDER TAILS,  
NICKEL UNDER PLATED OVERALL.
  4. BOARD LOCK: SPCC, TIN PLATED OVER NICKEL.
  5. SHELL: SPCC, NICKEL PLATED OVERALL.
  6. RIVET: Zn ALLOY, NICKEL PLATED OVERALL.
1. MATING FORCE: 4.5KG/MAX.
  2. UNMATING FORCE: 1.0-4.0KG.
  3. DIELECTRIC WITHSTANDING VOLTAGE:  
500V AC R.M.S. FOR ONE MINUTE.
  4. INSULATION RESISTANCE:  
1000MΩ MIN AT 500V DC.
  5. CONTACT RESISTANCE: 30mΩ MAX.
  6. OPERATING TEMPERATURE : -25°C TO +85°C.



RECOMMEND PCB LAYOUT  
TOLERANCE: ±0.05  
TOP VIEW

REV	ECN NO	DESCRIPTION	DATE
A	JIONS-DVL-0002		2011/02/01

**Jions** 北京玖恩启明电子科技有限公司

				TITLE:	
X. ±0.30		APPR:	Mr. wu		
.X ±0.20					
.XX ±0.10		CHKD:	Mr. wu		
.XXX±0.05					
X° ±2°		DR:	Gus chong		
X° ±1°					
		UNITS:	SCALE:	DWG NO:	
		mm	1:1	客户图	
				WWW. jions. com. cn	
				SHEET:10F	
				REV:	